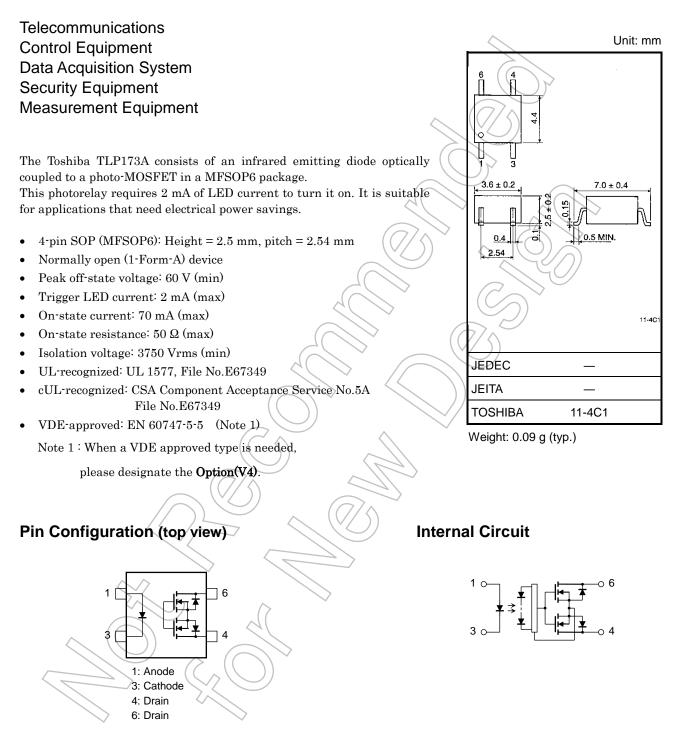
TOSHIBA Photocoupler Photorelay

TLP173A



TOSHIBA

Absolute Maximum Rating (Ta = 25°C)

	Characteristics	Symbol	Rating	Unit	1
	Forward current	lF	50	mA	1
	Forward current derating (Ta \ge 25°C)	∆I _F /°C	-0.5	mA/°C	
	Pulse forward current (100 μs pulse, 100 pps)		1	A	
LED	Reverse voltage	VR	5	(\mathbf{v})	>
	Diode power dissipation	PD	50	mW	
	Diode power dissipation derating (Ta $\ge 25^{\circ}$ C)	∆P _D /°C	-0.5	mW/°C	
	Junction temperature	Тј	125	°c	
	Off-state output terminal voltage	Voff	60)> v	
	On-state current	ION	70	mA	
Detector	Forward current derating (Ta \ge 25°C)	∆lon/°C	-0.7	mA/°C	
Detector	Output power dissipation	Po	196	mW	
	Output power dissipation derating (Ta \ge 25°C)	ΔPo/°C	-1.96	mW / C	
	Junction temperature	Ti	125	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	$\left(\right)$
Storage te	emperature	Tstg	-55 to 125	0°C	\bigcirc
Operating	temperature	Topr	-40 to 85	(Jo	1
Lead sold	ering temperature (10 s)	Tsol	260	°C	
Isolation v	oltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)	BVs	3750	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

- Note: This product is more sensitive than conventional products to electrostatic discharge (ESD). It is therefore all the more necessary to observe general precautions regarding ESD when handling this component.
- Note 1: LED pins are shorted together. Detector pins are also shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	VDD	_	_	48	V
Forward current	IF	_	3	25	mA
On-state current		_	_	60	mA
Operating temperature	Topr	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	$V_R = 5 V$	_	_	10	μA
	Capacitance	CT	V _F = 0 V, f = 1 MHz	/-	30	_	pF
Detector	Off-state current	IOFF	Voff = 60 V	$\langle \langle \rangle$	1	1000	nA
Delector	Capacitance	COFF	VOFF = 0 V, f = 1 MHz	\mathcal{L}	10	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	IFT	ION = 70 mA		0.6	2	mA
Return LED current	IFC	IOFF = 100 μA	0.1		/	mA
On-state resistance	Ron	ION = 70 mA, IF= 3 mA	-0	25	50	Ω
olation Characteristics (Ta =	25°C)				>	

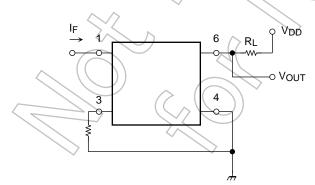
Isolation Characteristics (Ta = 25°C)

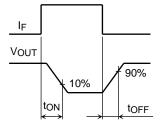
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	2,	40				
Capacitance input to output	Cs	Vs = 0 V, f = 1 MHz		0.4		pF
Isolation resistance	Rs	V_S = 500 V, R.H. \leq 60 %	5 × 10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVs	AC, 60 s	3750	_		Vrms

Switching Characteristics (Ta = 25°C)

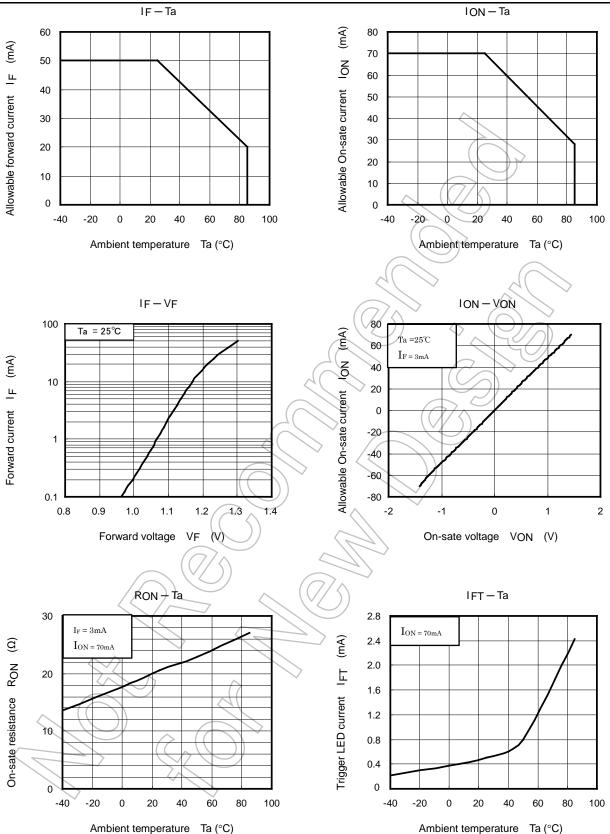
Ch	naracteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time		ton	$R_L = 200 \Omega$ $V_{DD} = 10 V, I_F = 3 mA$	(Note.2)		1.0	5.0	
Turn-off time		tOFF	$R_L = 200 \Omega$ $V_{DD} = 10 V, I_F = 3 mA$	(Note.2)		0.5	5.0	ms

Note 2: Switching time test circuit

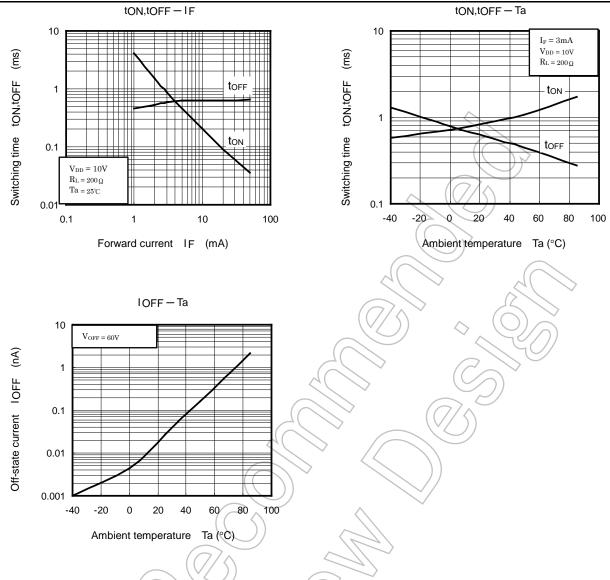




 $\sim (7/5)$

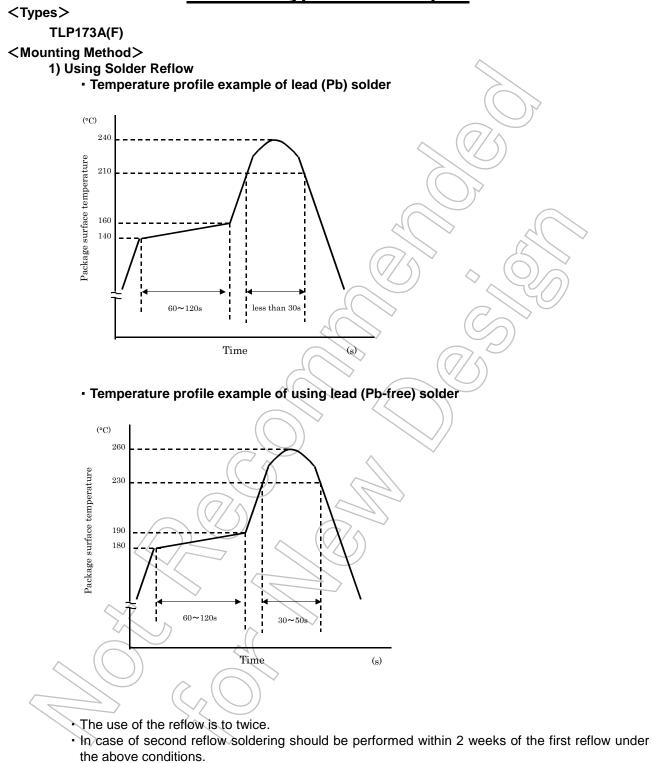


NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Precautions about the Soldering of the SMD Type Photocoupler



2) Using Solder Flow (for lead (Pb) solder, or lead (Pb)-free solder)

- Please preheat is at 150°C between 60 and 120 seconds.
- Complete soldering within 10 seconds below 260°C. Each pin may be heated at most once.
- The use of the reflow is to once.

3) Using a Soldering Iron

• Complete soldering within 10 seconds below 260°C, or within 3 seconds at 350°C. Each pin may be heated at most once.

Specification for Embossed-Tape Packing (TP) for Mini-Flat Coupler

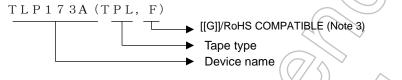
1. Applicable Package

Package	Product Type
MF-SOP6	Mini-Flat Coupler

2. Product Naming System

Type of package used for shipment is denoted by a symbol suffix after a product number. The method of classification is as below.

(Example)



3. Tape Dimensions

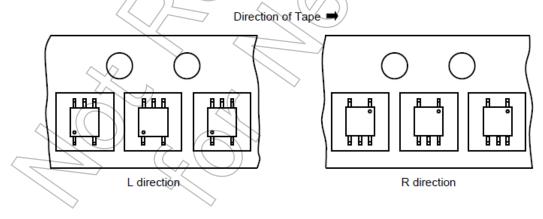
3.1 Specification Classification Are as Shown in Table 1

Table 1	Таре Туре	Classification
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Tape type	Classification	Quantity (pcs / reel)
TPL	L direction	3000))
TPR	R direction	3000

3.2 Orientation of Device in Relation to Direction of Tape Movement

Device orientation in the recesses is as shown in Figure 1.





3.3 Empty Device Recesses Are as Shown in Table 2.

Table 2 Empty Device Recesses

	Standard	Remarks
Occurrences of 2 or more successive empty device recesses	0 device	Within any given 40-mm section of tape, not including leader and trailer
Single empty device recesses	6 device (max) per reel	Not including leader and trailer

3.4 Start and End of Tape

The start of the tape has 50 or more empty holes. The end of tape has 50 or more empty holes and two empty turns only a cover tape.

3.5 Tape Specification

- (1) Tape material: Plastic (protection against electrostatics)
- (2) Dimensions: The tape dimensions are as shown in Figure 2 and Table 3.

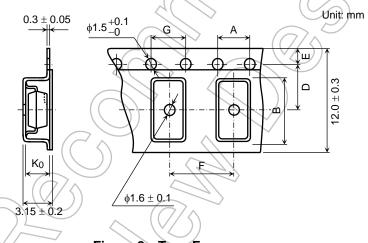


Figure 2 Tape Forms

Table 3 Tape Dimensions

			Unit: mm Unless otherwise specified: ±0.1
~	Symbol	Dimension	Remark
	A	4.2	—
	в	7.6	—
	D	5.5	Center line of indented square hole and sprocket hole
	E	1.75	Distance between tape edge and hole center
	F	8.0	Cumulative error $\frac{+0.1}{-0.3}$ per 10 feed holes
	G	4.0	Cumulative error $\frac{+0.1}{-0.3}$ per 10 feed holes
	K ₀	2.8	Internal space

Unit: mm

Dimension

Φ330 ±2

Φ80 ±1

Φ13 ±0.5

2.0 ±0.5

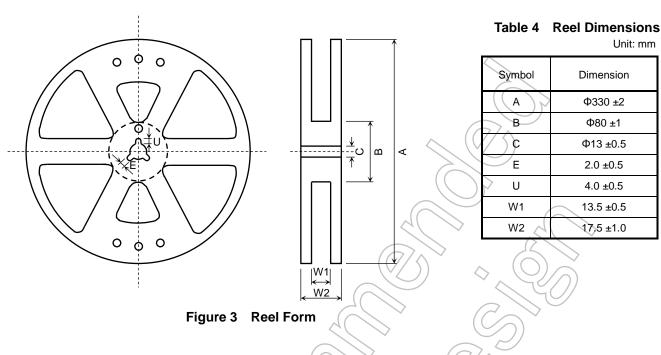
4.0 ±0.5

13.5 ±0.5

17,5 ±1.0

3.6 Reel

- (1) Material: Plastic
- (2) Dimensions: The reel dimensions are as shown in Figure 3 and Table 4.



4. Packing

Packed in a shipping carton.

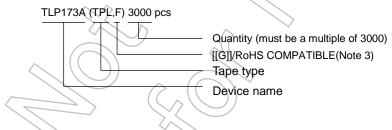
5. Label Indication

The carton bears a label indicating the product number, the symbol representing classification of standard, the quantity, the lot number and the Toshiba company name.

6. Ordering Method

When placing an order, please specify the product number, the tape type and the quantity as shown in the following example.

(Example)



Note 3: Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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